

Application Specific Discretes A.S.D.<sup>TM</sup>

#### FEATURES

- UNIDIRECTIONAL FUNCTION
- PROGRAMMABLE BREAKDOWN VOLTAGE UP TO 265 V
- PROGRAMMABLE CURRENT LIMITATION FROM 50 mA TO 550 mA
- HIGH SURGE CURRENT CAPABILITY
  IPP = 100A 10/1000 μs

#### DESCRIPTION

Dedicated to sensitive telecom equipment protection, this device can provide both voltage protection and current limitation with a very tight tolerance.

Its high surge current capability makes the L3100B a reliable protection device for very exposed equipment, or when series resistors are very low.

The breakdown voltage can be easily programmed by using an external zener diode.

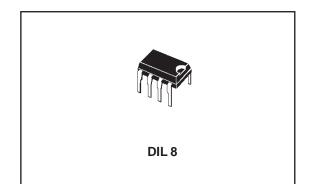
A multiple protection mode can also be performed when using several zener diodes, providing each line interface with an optimized protection level.

The current limiting function is achieved with the use of a resistor between the gate N and the cathode. The value of the resistor will determine the level of the desired current.

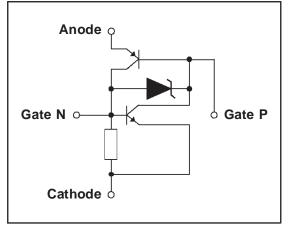
#### COMPLIES WITH THE FOLLOWING STANDARDS :

CCITT K17 - K20	10/700	μs	1.5	kV
	5/310	μs	38	А
VDE 0433	10/700	μs	2	kV
	5/200	μs	50	А
CNET	0.5/700	μs	1.5	kV
	0.2/310	μs	38	А

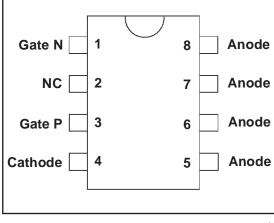
# OVERVOLTAGE AND OVERCURRENT PROTECTION FOR TELECOM LINE



#### SCHEMATIC DIAGRAM



# **CONNECTION DIAGRAM**



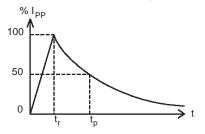
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# ABSOLUTE MAXIMUM RATINGS (T<sub>amb</sub>= 25 °C)

Symbol	Parameter	Value	Unit	
IPP	Peak pulse current (see note 1)10/1000 μs 8/20 μs		100 250	A
Ітѕм	Non repetitive surge peak on-state current	50	A	
T <sub>stg</sub> Tj	Storage temperature range Maximum operating junction temperature	- 40 to + 150 + 150	°C °C	
TL	Maximum lead temperature for soldering	230	°C	

# Note 1 : Pulse waveform $10/1000 \, \mu s$

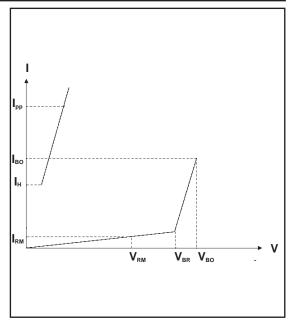


# THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R <sub>th (j-a)</sub>	Junction-to-ambient	80	°C/W

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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25 \text{ °C}$ )		
Symbol	Parameter	
Vrm	Stand-off voltage	
I <sub>RM</sub>	Reverseleakagecurrent	
V <sub>BR</sub>	Breakdown voltage	
V <sub>BO</sub>	Breakovervoltage	
Ін	Holding current	
I <sub>BO</sub>	Breakover current	
I <sub>PP</sub>	Peak pulse current	
V <sub>GN</sub>	Gate voltage	
I <sub>GN</sub> , I <sub>GP</sub>	Triggering gate current	
V <sub>RGN</sub>	Reverse gate voltage	
С	Capacitance	



## **OPERATION WITHOUT GATE**

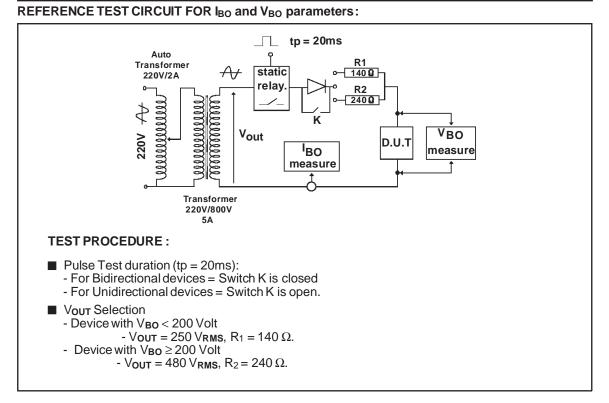
	I <sub>RM</sub> @	V <sub>RM</sub>	V <sub>BR</sub> (	@ k	V <sub>BO</sub>	@	во	Ι <sub>Η</sub>	С
Туре	max.		min.		max.	min.	max.	min.	max.
						note 1		note 1	note 2
	μΑ	V	V	mA	v	mA	mA	mA	pF
L3100B	6 40	60 250	265	1	350	200	500	280	100
L3100B1	6 40	60 250	255	1	350	200	500	210	100

## **OPERATION WITH GATES**

	Vgn @ Ign	= 200 mA	I <sub>GN</sub> @ VA	c = 100V	V <sub>RGN</sub> @ I <sub>G</sub> = 1mA	I <sub>GP</sub> @ V <sub>AC</sub> = 100V
Туре	min.	max.	min.	max.	min.	max.
	V	V	mA	mA	V	mA
L3100B/B1	0.6	1.8	30	200	0.7	150

Note 1: See the reference test circuits for I<sub>H</sub>, I<sub>BO</sub> and V<sub>BO</sub> parameters. Note 2:  $V_R = 5 V$ , F = 1MHz.

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## FUNCTIONAL HOLDING CURRENT (I<sub>H</sub>) TEST CIRCUIT = GO - NOGO TEST.

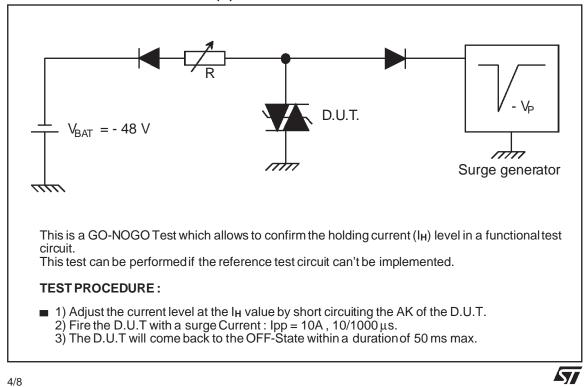
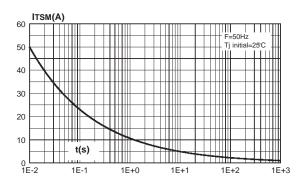


Figure 1 : Surge peak current versus overload duration.

**Figure 2** : Relative variation of holding current versus junction temperature.



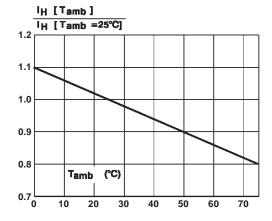
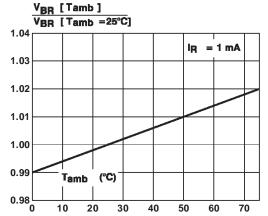
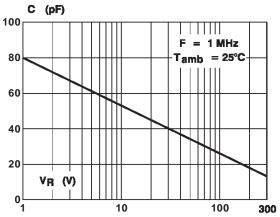


Figure 3 : Relative variation of breakdown voltage versus ambient temperature.





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# **APPLICATION CIRCUIT**

Overvoltage Protection and Current limitation

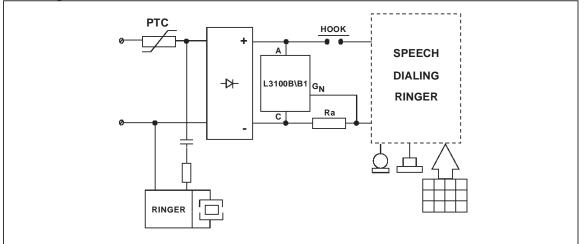
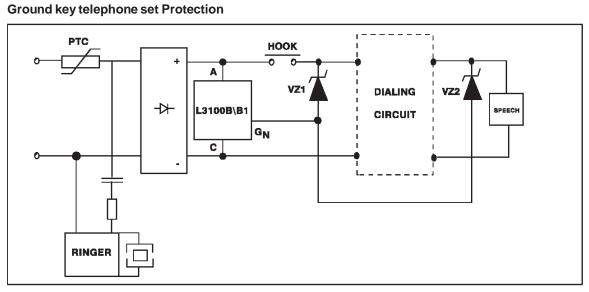


Table below gives the tolerance of the limited current  $I_T$  for each standardized resistor value. The formula (1) has been used with  $V_{GN}$  values specified at the typical gate current level  $I_{GN}$ .

CURRENT TOLERANCE	
RIτIτΩmAmA(±5%)minmax	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$I_{T} = \frac{V_{GN}}{Ra} + I_{GN}$
16.00      75      263        18.00      70      256        20.00      66      250	V <sub>GN</sub> @ I <sub>GN</sub>
20.00      66      250        22.00      62      245	Min. Max. Typ.
24.00      60      242        27.00      56      237	V V mA
30.00 54 233	0.75 0.95 100

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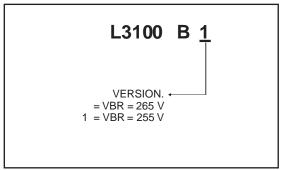


## **PROTECTION MODES :**

**ON HOOK** = Ringer circuit protection is ensured with breakdown voltage at 265 V.

**OFF HOOK** = In dialing mode and in speech mode, the breakdown voltage of L3100B can be adapted to different levels with zener diodes.

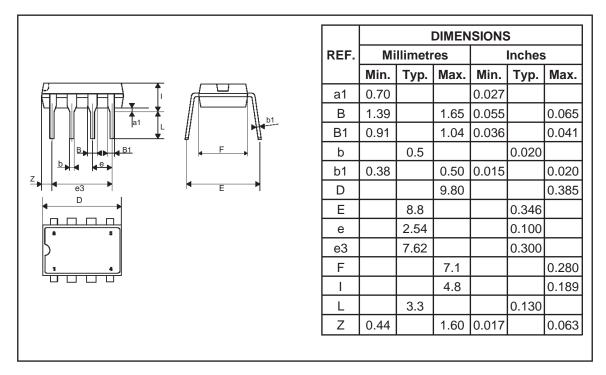
### **ORDER CODE**



MARKING : Logo, Date Code,part Number.



PACKAGE MECHANICAL DATA. DIL 8 (Plastic)



#### Weight: 0.59 g

Packaging : Product supplied in antistatic tubes.

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